





Service Manual for Prophet

HTC Proprietary Confidential Treatment Requested

Rev. A02 Jan, 2006





HTC Corp. Engineering Mobility

TITLE: Service Manual

		T				1
REV. NO.	DATE	CONTENTS	DEP.	REVISED	APP'D	STGE.PER.
A01	Nov, 29, 2005	First Draft	Technical Support	HB Chen		
A02	Jan,09,2006	Modify Hard reset mode and enter bootloader mode description	Technical Support	HB Chen		





Table of contents

1. Introduction ·····	5
1-1. PRODUCT SPECIFICATION	5
2. Exploded Diagram	9
3. ASSEMBLING AND DISASSEMBLING 1 3.1 DISASSEMBLING 1 3.2 ASSEMBLING 1 3.3 LCM ASSEMBLY NOTICE 2	1
4. DIAGNOSTICS PROGRAM AND WINCE TEST ITEM	24 24 24
5. Main Battery Re-certify Procedure 2 5.1 Flow Chart 2 5.2 Measurement Procedure 2 5.3 Battery Rundown Test 3	27 28
6. Leakage current measurement	3
7. COSMETIC INSPECTION CRITERIA	37 37 37
8. OS, GSM ROM IMAGE REFLASH PROCEDURE 3	39
9. FTA (FAULTY TREE ANALYSIS) 5	50
10. Spare Part List 5	6
.11PHTO OF SPARE PART5	57
APPENDIX	59 52





D. BOARD LEVEL 2.5 REPAIRS65

1. Introduction





This manual provides the technical information to support the service activities of Prophet.

This document contains highly confidential information, so any or all of this document should not be revealed to any third party.

2. Product Specification

Platform

Microsoft Windows Mobile 2005 for Pocket PC Edition

– English, Spanish, Traditional Chinese,
 Simplified Chinese,

Italian, Portuguese, German

Dimensions: Main unit :108mm(L) *58mm(W) * 18.1 mm(T)

Weight :150g with battery pack

Processor

TI OMAP 850

Memory

Flash ROM: 128MB/256MB

Flash RAM: 64MB mobile Double Data Rate (DDR)

LCD Module

- 2.8 "240 X320 dots resolution
- 64K-color TFT Transflective LCD with white LED back light.
- Sensitive touch screen
- Support screen rotation battery meter, and key lock icons on the lower right corner of today screen

GSM/EDGE functional

- Audio codec:AMR,EFR,FR,HR
- Tri-band 900/1800/1900MHz, or 850/900/1900
- Internal antenna for tri-band GSM
- SMS (MO,MT) concatenated SMS (640 characters)
- Supplement services
 - ~ Call holding/waiting/forwarding
 - ~ Call barring
 - ~ CLI (Calling Line Identity)
 - ~ Display own number





- ~ Network selection
- ~ Cell broadcast
- ~ Multi-party conference call
- ~ Spool icon
- ~ Phase 2+unstructured supplementary
- ~ Network Lock
- ~ CPHS

DEGE Functionality

- EGPRS class B
- Multi-slot class 10
- PBCCH
- Link Adaptation and Incremental Redundancy

SIM

- Accept 1.8V and 3V operation
- SIM Application Tool Kit release 98 class 3
- Over the Air (OTA) programming
- FND
- AND
- SDN
- Security PIN 1&2

Stylus

Lock type mechanism

Keyboard/button/switch

- One power button
- One voice dial/voice record (long press) on the same key
- One volume control button (up and down)
- One Camera capture (portrait mode default)
- One 5-way navigation Pad
- Send/Hands-free button
- End button
- 2 AP buttons (Start or Portal (by operator request)-left button, OK-right button)

Notification

 One bi-color LED (Green and Red) LED for GSM standby, GSM message, GSM network status, notification, and charging ststus





- Blue LED for Bluetooth notification .
- Notification by Sound and Message on the display
- Vibrator for notification

Audio

- Built-in Microphone,
- Receiver
- Speaker
- Loud speaker for hands-free support
- Full duplex
- Audio sampling rate
 16-bits with 8KHz, 11KHz, 16KHz, 22KHz, 44.1KHz,
- AMR/AAC/WAV/WMA/MP3 stereo

Camera

- Color CMOS VGA/1.3/2.0Mega-Pixel camera with macro
- Preview Mirror

Power

- Battery
 - ▶ Removable rechargeable Lithium Ion Polymer battery, 1200mAh (Typical)
 - ▶ Charging time: less than 4 hours

Battery life:

- ▶ WMA:12 hours (Magneto test case)
- ▶ WMV:8 hours (Magneto test case)
- ▶ Talk time : 3.5~5 hours (at nominal RF Tx power level)
- ▶ Standby time: 150~200hors
- AC Adapter
 - ▶ AC input: 100 ~ 240 Vac, 50/60Hz
 - ▶ DC Output voltage: 5V and 1A

Interface

- Infrared Port IrDA SIR
- One Audio Jack (2.5)
- 1.8V and 3V SIM card
- One SDIO/MMC card slot
- One External antenna connector
- One Mini USB connector





Device to Device connectivity

Bluetooth

- Compliant with V 2.0
- Class 2 transmit power
- Support profiles :
 - V Generic Access
 - V Generic Object Exchange profile
 - V Serial Port Profile
 - V Headset Profile
 - V Object Push Profile
 - V DUN Client Profile
 - V File Transfer Profiler
 - V AV Profiler
 - V PAN Profile
 - V HID Profile
 - V Hands-free Profile
- Infrared IrDA SIR
- Mini-USB
- SDIO/MMC

Accessories

- Sync. Cable (Mini-USB/USB)
- Carrying Case
- AC adapter W/ power plug
- Car adapter
- Car Kit (capable of muting car stereo when incoming call or call proceeding)
- Stereo Wired headset-stereo earpiece with microphone
- User manual ,quick start guide, sync, software CD
- Stereo Bluetooth headset-mono earphone with microphone
- Optional Battery (1200mAh)
- Car kit w/car stereo mute function
- Travel charger (optional)
 - ~Mini-USB
 - ~1 slot for 2nd battery charging





Cradle (optional)

Regulatory

- R&TTE : EMC/EMI,CEM, Safety
- PTCRB
- FCC
- Microsoft Window Mobile Version 5.0
- USB Certification
- WiFi certification

Value Added Applications

MASD

- Photo Album with editing picture capability
- Camera capture utility
- Camcorder (H.263 and MPEG4 encoder and decoder)
- Zip
- Polyphonic MIDI Ring tone Engine
- SmartDial

MSD

- MMS with video clip support
- Voice dial via device, wire headset, or BT headset
- JAVA virtual machine (J2ME CLDC, MIDP 2.0,)
- FAX
- OMA DRM2.0
- Blackberry e-mail client (operator dependent)

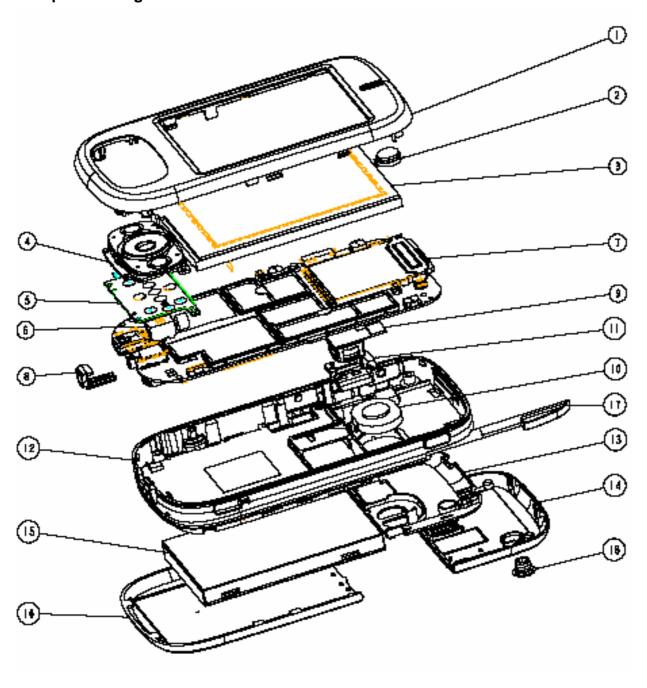
SW

- Wireless Modem (IR,USB, Bluetooth)
- Key lock ,screen rotation ,and battery meter





2. Exploded Diagram







3. Assembling and Disassembling

3.1 Disassembling



Tools needed for Assembling and Disassembling the Prophet.

- 1. Lens Cleaning Tissue.
- 2. Philip Screw Driver 000X50
- 3. Philip Screw Driver 2.5X40.
- 4. Torex Screw Driver T6X40
- 5. Tweezers
- 6. Special Made Plastic Stick.

Tweezers.(Suggest to use plastic made)



- 1. Pull up to release the Stylus.
- 2. Remove the SD Card Filler.
- 3. Remove the Antenna Insert Rubber. as indicated on the left.



Next, Remove the battery cover by slightly push backward the battery cover.

Note: Cover-Battery 74H00564-0XM







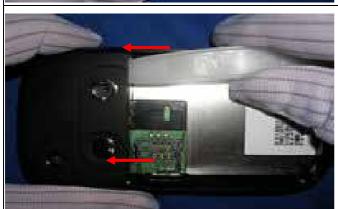
.Release the Battery P/N: 35H00051-03M

Warning: To reduce risk of fire or burns, do not disassemble, crush, puncture, short external contacts, or dispose of in fire or water. Replace only with specified batteries. Recycle or dispose of used batteries properly.





Turn left the Philips screw driver and looses the hook of antenna cover.



To remove antenna cover

Please use Precision Plastic special tool flat (θ) type 1.2 mm and insert in to the two hole as shown on picture.

Insert in angle:30 °

Cover-Antenna P/N: 74H00563-0XM







Remove the 2 screws for release internal antenna.



Next, remove the Antenna; unlock the connector lock with the plastic stick.

Antenna P/N :36H00345-01M



Next, remove 2 screws to disassemble bezel and housing







Next, start disassembly the housing cover Please be noticed that improper way of disassembly may caused the cover worn easily

- **1.** Insert the plastic stick to the gap between front and rear cover deep inside.
- 2. Move the stick slightly from lower side to upper to release the 6 hooks (3 each at both side)



Release all hooks at both side



1Take off the speaker from housing 2.Disassembly housing and Bezel.



For Camera FPC, lift the connector lock upwards from both ends at the same time as indicated in the picture. The angle must not exceed 90 degrees.

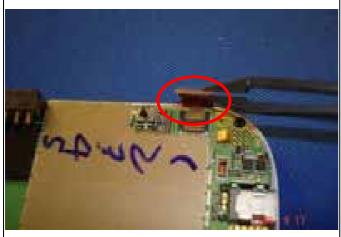






Next, disassembly the speaker connector using tweezers and housing.

Speaker P/N:36H00338-00M



Next, disconnect switch board and Main board FPC.



Next, remove the LCD from MB.

- 1.Unlock the LCD connector with plstic special tool (hook side)
- 2. Take out the FPC with plastic tweezers.

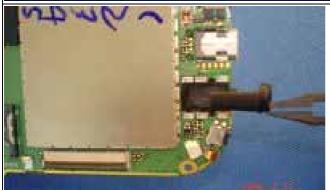






Remove 2 screws on main board to disassemble main board and bezel assembly.

Note that screw P/N is 72H00724-00M.



Remove the audio jack holder with plastic tweezers

Note that holder P/N is 71H00960-00M



Separate the Audio Daughter Board from the Main Board as indicated on the left.

Note that Daughter Board P/N is: 51H00320-50M



- 1. Remove Vibrator from bezel.
- 2.Remove Spacer on switch board
- 3.Remove on GASKET switch board
- 4.Remove gasket on switch board

Note those P/N 1 : **36H00180-00M**

2:76H00748-00M

3:72H00498-00M

4:72H00548-00







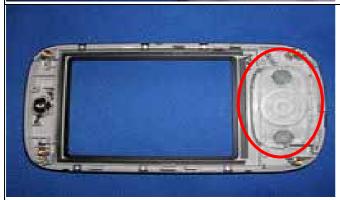
Remove 4 screws on switch board to disassemble switch board and bezel assembly.

Note that screw P/N is 72H00724-00M.



Next, to separate the LCD from the bezel as indicated on the left.

Note that LCM P/N is:60H00032-00(Samsung)/60H00037-00 M(Toppoly)



Next, Remove the Navigation keypad rubber from the bezel.

Note that Navigation key pad Assembly P/N is: **74H00537-01M**







Remove the Receiver from bezel with plastic tweezers

Note that receiver P/N:36H000253-01M

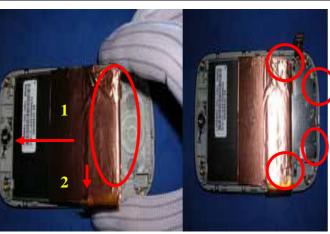
Done for disassembly

3-2 Assembling



- 1.Assembly receiver into its place on the bezel
- 2. Put the Rubber keyboard on the bezel.

Note: there're 4 guide pins on bezel, so please aim at them when the Rubber keyboard is put on it.



LCM assembly:

- 1-1Insert LCM into its place on the bezel , the angle about 30 degrees .
- 1-2.Put down LCM.

Note: if a new LCD needs to be replaced, please paste two copper foils before assembly

2. Put the switch board on Action button and fasten 4 screws as indicated on the left. Torque: 0.5 kg+0.05cm-kg







- 1. Put the gasket on switch board.
- 2.Put the gasket on switch board
- 3. Put the spacer on switch board
- 4. Put the Vibrator into its place on the bezel.

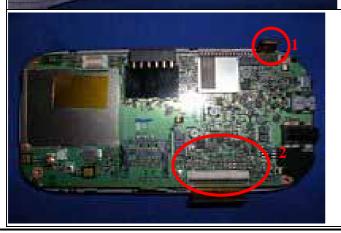


Assemble the Audio daughter board on main board and please pay attention on the Antenna location.



- 1. Put the Holder on audio jack.
- 2.Fasten 2 screws to fix main board on bezel as indicated on the left.

Torque: 0.5 kg+0.05cm-kg



- 1. Press down S/W board FPC connector into the connector of M/B.
- 2. Insert LCM FPC into M/B connector.







- 1. Insert the speaker connector into the connector of the M/B.
- 2.Assembly the Camera module



- 1. Assembly the housing.
- Please set the volume button on the center before assembly.
- 2. Set up speaker on housing.



Set up the antenna on the top of the unit.

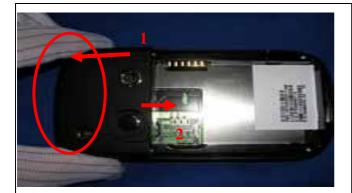


Fasten 4 screws on rear side

Torque: 1.2 kg+0.1cm-kg







Assembly the antenna cover

Note:1. insert from the top of hooks 2.then press down the cover



- 1. put the battery into the unit.
- 2. slightly push forward the battery cover.



- 1. Insert the Stylus.
- 2. Insert SD Card Filler into the slot.
- 3. Insert the Antenna Rubber. as indicated on the left.







The assembly procedure is done.

The Unit Assembly is done already.

3-3. LCM assembly notice

- 1. Stick 2 Mylars on the back of the LCM (Mylar P/N: 76H00967-00M) as figure1
- 2. Apply the copper foil to LCM back side as figure2 (Copper foil P/N: 72H00782-00M)



Figure 1



Figure 2





4. Diagnostic Program and Win CE test item

4.1 Tools required

SD card with Diagnostic program loaded.

4.2 How to enter Diagnostic Program

- 4.2.1: Insert SD card with Diagnostic program loaded to the unit.
- 4.2.2 Press & hold the Camera Button with your Thumb and jab the reset with Stylus.
- 4.2.3 Release the Stylus but keep pressing the Camera Button until the Boot Loader Screen comes out.

4.3 List of Diagnostic / WinCE Test Items

	No.	Item	Description	Remark
	1	SDRAM Test	Check SDRAM Size/Write/Read	
	2	Display Test	Test the LCD display quality	
	3	Touch Test	Touch panel calibration test.	
	4	LED Test	Red/green/amber/key LED on/off test	
	5	Key Test	All buttons (Key) press/release test.	
	6	B.L Test	Three levels Backlight test.	
	7	Timer Test	Timer test	
apo	8	SD Test	SD card read/write/lock/unlock test.	
Program mode	9	Battery Test	Check battery capacity, current, voltage	
grar	Α	Vibrator Test	Test the function of Battery	
Pro	В	Checksum Test	Calculation ROM checksum Test.	
Diag.	С	Msys- Fromat	Clear call duration (including Talk time and E-user data)	
	D	SPK Play Test	Playback a simulation wave test.	
	Е	Rev Play test	Playback to Receiver	
	F	Hst Play	Playback to 3-ring earphone	
	G	IntRec- SpkOut	Internal record & playback	
	Н	IntRec- RevOut	Internal record & playback with Receiver	
	I	IntRec-HstOut	Internal record & earphone out	
	J	HstRec-HstOut	Earphone MIC record & earphone out	
		Upload To SD	For HTC Service Center upload Diagnostic to SD card.	





in CE	1	USB Test	Suggest to test in Windows CE	
Wii	2	SIR Test	Suggest to test in Windows CE	

4.4 Test Items Operation

How to select test item: Using navigation button -"Up" or "Down" to select the test items

How to execute the test program: Press "Action" button to start each of test items.

	No.	Item	Description		
эрс	1	RAM Test	Press Action button to process SDRAM test Display Size and read/write test. I will show OK if pass. Stop on fail.		
	Display Test Display Test		Unit prompts for different display page to detect the defect of LCD, lines or		
ram r	3	Touch Test	Tap the cross mark (+) with stylus on the correct location. Fail if no reaction		
Diag. program mode	4	LED Test	Action LED: Green→ Red→Blue Bluetooth Action LED: Green→ GSM Action keypad LED		
	5	Key Test	Follow the indication on device to press buttons for test.		
	6	Backlight Test	Press "Action to test LED and brightness level of LCD (three stages) and then return Test Menu.		
	7	Timer Test	Press Action to check if it shows "Test OK".		
	8	SD card Test	Lock SD card and insert to unit, then remove SD card		
	9	Battery Teat	Check battery capacity, current, voltage		
	А	Vibrator Test	Press Action, unit should vibrate, and then press Action to return Test Menu		
	В	Checksum Test	Press Action to calculate ROM checksum.		





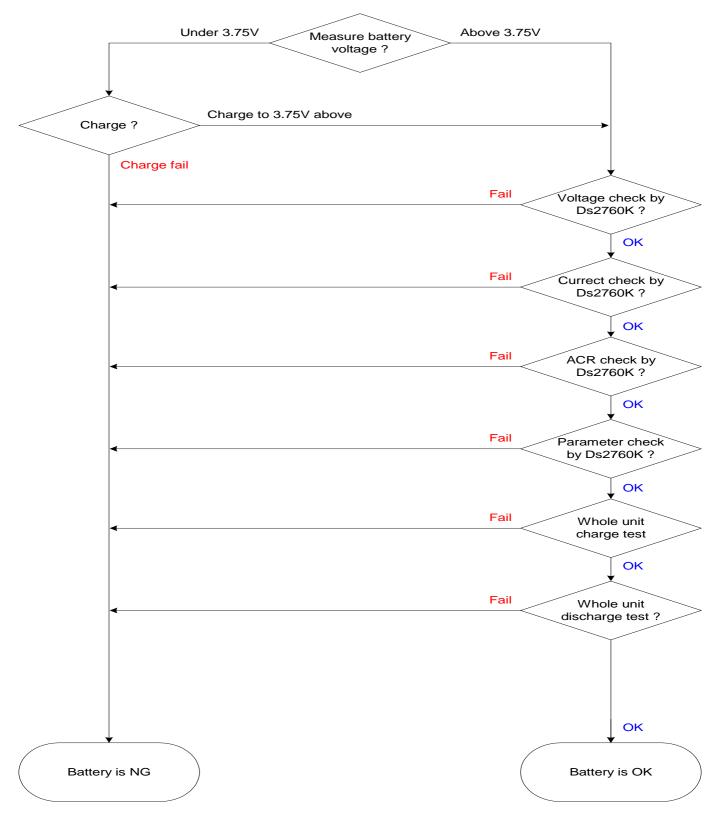
	С	Msys-Format	Press Action to clear call duration(talk time and end-user data) Playback to SPK Receiver Playback test	
	D	Spk Play test		
	Е	Rev Play test		
	F	Hst Play test	Earphone Playback test	
	G	IntRec Spkout	Intel Record and Speak out	
	Н	IntRec Revout	Intel Record and Receiver out	
	I	IntRec Hstout	Intel Record and Earphone out	
	J	HstRec Hstout	Earphone Record and Earphone out	
CE	1	USB Test	Plug USB cable to connect UUT to PC then and check if USB OK or not.	
WinCE	2	SIR Test	Use a device that can support SIR function to connect UUT.	

5. Main Battery Re-certify Procedure

5.1 Flow Chart



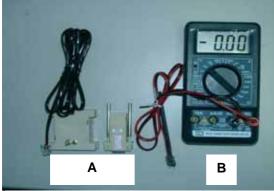








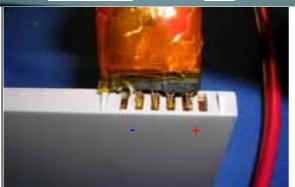
5.2 Measurement Procedure



Tools requirement:

- A. Battery testing fixture
- B. Multi-meter with battery detecting plug
- C. Win2000 or above OS PC system
- D. Ds2760K battery testing program.

Note: The Ds2760K program needs to installed onto PC in advance.



Step 1: Main battery voltage check

 To detect battery voltage by multi-meter through battery connector.



b. The battery voltage will appear on the multi-meter, make sure the voltage >= 3.75V above
 If the voltage < 3.75V please charge the main battery and then re-check the battery voltage must > 3.75V.

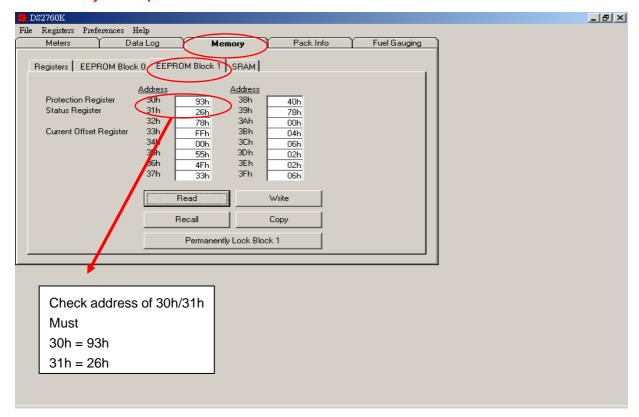
Step 2: Parameter check by DS2760K test program

 Contact battery to detect battery parameter by DS2760K program





The battery's core parameter areas as follows:



If the register address is incorrect, it means that the EEPROM is defective.







Step 3 : Whole unit charge test

Plug in AC adapter to unit, the charge light must be turn on (Red), If it is failed in charge test, replace another good battery for double check.



Step 4 : Whole unit discharge test

Unplug AC voltage, the charge light must be off, but the LCD screen must be still on display. If it is failed in discharge test, replace another good battery for double check.





If you still have the misgiving for the battery you can execute rundown test to verify.

- 5.3 Battery Rundown Test Procedure
 - (A) Tool Requirement: (1) Windows 2000 or above (2) Battery Rundown Software
 (3) USB Cable or Cradle (4) ActiveSync 4.0 or above
 - (B) Please charge your unit to full capacity for battery (4 hours) before doing the test.

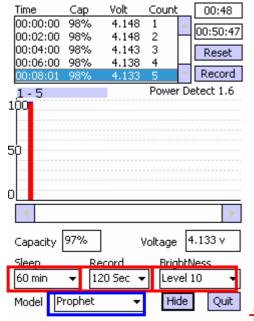
Step 1: It is required to save powerdetect.exe and model.txt in the same folder under WinCE via ActiveSync.



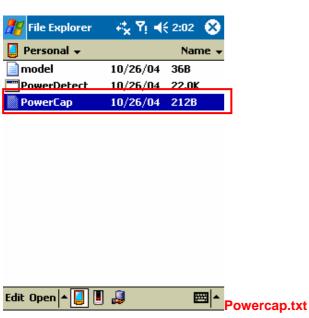
- Step 2: It is unnecessary to adjust power management setting by using rundown test program.
- Step 3: Execute powerdetect.exe under WinCE, it will enter Sleep Mode after **one**hour and generate a file named powercap.txt log.

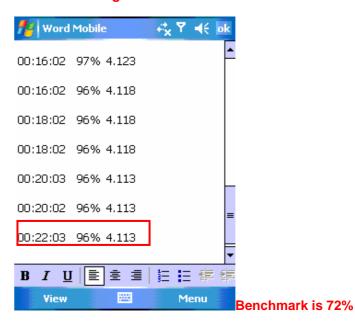






→ Record every two minutes & Brightness is maximum





Step 4: Tap powercap.txt log to check if the rest battery capacity. If under 72%, please replace a new battery.





Chapter 6 – Leakage current measurement

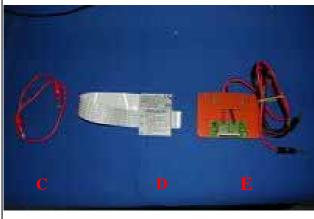
This is a quick method to measure if any abnormal leakage current on main board which caused high power consumption compare to GOOD main board.

- (1) Requirement:
 - Power Supply
 - Micro-current Meter
 - Current series JIG
 - CABLE
 - Battery JIG



Equipment need:

- A. Power Supply (set at 4 V /1A).
- B. Micro-Current Meter (support 0.5mA ~ 1A).



2. Fixture needed

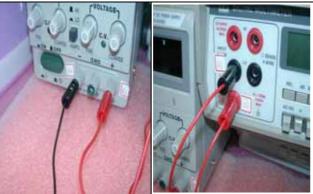
- C. Cable
- D. Battery with extension cable
- E. Current series jig.(with black and red cable)





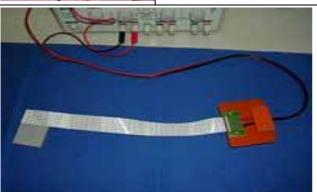


3. Connect cable (C) to positive polarity of power supply (A) and current meter (B)

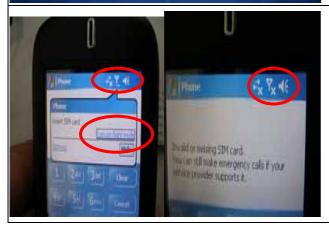


4. Connect cable of fixture(E) to negative polarity of power supply (A) and current meter (B)

Note: black cable to power supply (A) and red cable to current meter (B)



5. Setting is **Ready now for testing** (Don't turn the power on at this moment)



6.Turn on power supply (4V) and current meter (2A)

Set the unit to:

- * Flight mode
- * Turn on Bluetooth

Note: Need to put SIM card first on the unit.







7. Measure flight mode current

Setting display off:

start→settings-→System→backlight, set the cursor to Power Save, display will be off, in this condition, please check current value on the current meter,

Current value must under **65mA**, if over, it means M/B failed, please replace M/B for repair.

Unit is turn on and no back Light



8. Switch OFF the unit.

Unit is turn off and no display



12. Measure power off current Check current value on the current meter, Current value must under 5 mA, if over, it means M/B failed, please replace M/B for repair.





Conclusion:

If current consumption are passed at both of flight and power off mode, it means M/B is GOOD.

If there is any item FAILED at flight or power off mode, it means M/B is failed, please replace M/B for repair.

Measurement parameter

Measurement mode	Measured Current	REMARK
	Under 65mA	MB is good
Flight Mode		
(Idle mode)	Over 65mA	Fail, MB need to be futher
		repaired
	Under 5 mA	MB is good
POWER OFF		
(Sleeping mode)		Fail, MB need to be futher
	Over 5 mA	repaired





7. Cosmetic Inspection Criteria

6.1. Definition of Cosmetic Standard

B Standard is for refurbishment inspection.

7.2. Visual Inspection Requirements

- 2.1 Examination of the device shall be made with workbench light turned on.

 Ambient illumination is to be 1000±20 lux.
- 2.2 The inspector shall examine the device at a distance of 30cm± 30degrees for approximately 5 seconds.
- 2.3 If a visual defect is noted, the inspector shall have an additional 7 seconds to closely examine the defect and classify it according the criteria table.

7.3. Definitions of Inspection Defects and Areas

Scratch: A linear cut that penetrated beyond the surface of the material.

A scratch can be felt by running your finger over it.

Dot / Dent: A recessed spot or void in the surface of the material.

Lint: A linear foreign object beyond the surface of the LCD

Bump: A hump in the surface of material

Area I: LCM, Bezel including phone key, APP button, action key and LED lens.

Area II: Keyboard, Housing, back side of battery, antenna cover, release button, stylus and side buttons.

Area III: Inner side of battery (not include battery), inside of SD connector, inside of USB port inside of Earphone jack and other area marked in the figure below.

D: Diameter/ L: Length/ W: Width/ Number: Number of defects/ S: Distance of dot to dot

Remark: 1. Crack is not allowed. 2. All dimensions in millimeters..

Area II Area III Area III













7.4. Cosmetic Criteria Table

	Specs Item	B standard (Refurbishment specs)		Specs Item	B standard (Refurbishment specs)
	Bright dot**	Red + Green + Blue 2 dots 0.1mm< D 0.3mm		Scratch	1) L 15mm, W 0.4mm 2) Total number 5
	Dark dot**	Dark dots 2 0.1mm< D 0.3mm		Spot	1) D < 1mm, S 10mm 2) Total number 4
	Dark or Bright line	None	Area 3	Dent	1) D < 1mm, S 10mm 2) Total number 4
LCM*	Scratch	Total scratch number 3 w 0.1mm 1.0mm L 2.0mm		Rump	1) D < 1mm, S 10mm 2) Total number 4
	Lint	Total number 2 0.03mm <w 0.01<br="">1.0mm L 2.0mm</w>		Bur	1) L 3mm, W 0.254mm 2) <mark>No Hand Scrape</mark>
	Particle	Total number 3			
	Breakage on T/P	None	IR Cap	*Scratch	1) L 3mm, W 0.2mm 2) Total number 3
	Scratch	1) L 3mm, W 0.15mm 2) Total number 3		Scratch	1) L<7mm, W<0.15mm 2) Total number<3
	Spot	1) D < 0.3mm, S 15mm 2) Total number 3	Stylus	Protruding over the top of bezel	None
	Dent	1) D < 0.5mm, S 15mm 2) Total number 4		Deformed/ Missing/ Loosen	None
Area 1	Bump	1) D < 0.5mm, S 15mm 2) Total number 4			
	Bur	1) L 3mm, W 0.254mm 2) No Hand Scrape		Gap between touch panel and bezel (Skip corner)	Gap < 0.9mm
	Bright mark	L 2.5mm W 0.25mm N 2		Gap between bezel and housing	Gap < 0.6mm
				Buttons on the bezel	Button needs to be pressed smoothly
	-		Gap	-	Button needs to be pressed smoothly
	Scratch	1) L 7mm, W 0.15mm 2) Total number 3	Сар	Gap between housing and battery lock	Gap < 0.5mm
	Spot	1) D < 0.7mm, S 15mm 2) Total number 4		Gap surrounding the buttons on the side	1) 0.05mm <gap 2)="" <0.6mm="" be="" button="" needs="" pressed="" smoothly<="" td="" to=""></gap>
Area 2	Dent	1) D < 0.6mm, S 15mm 2) Total number 4			1) 0.05mm <gap 2)="" <0.6mm="" be="" button="" needs="" pressed="" smoothly<="" td="" to=""></gap>
	Bump	1) D < 0.6mm, S 15mm 2) Total number 4			
	Bur	1) L 3mm, W 0.254mm 2) No Hand Scrape			
	Bright mark	1) L 3.0mm, W 0.25mm 2) Total number 4			

^{*} The total of LCM defect number must be less than 5 counts.

^{**} The total of defected dots (bright dot and dark dots) must be less than 4.





8. OS, GSM Image Reflash Procedure System Requirement:

- -Windows 2000
- -USB Cable or Cradle
- -MTTY.exe
- -Master Unit with most update Rom Code
- -64 MB SD/MMC card SD card

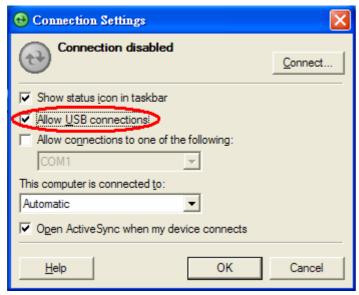
Caution: The unit must have at least 70% of battery capacity before starting the re-flash process. Charge the battery in advance if necessary.

Note: For the master unit, you could prepare it on these following ways:

- Take one from Swap unit with most update Rom Code.
- Build one first by connecting to customer web for OS Upgrade/ Download Via RUU.

Execute RUU:

- 1.Boot up device into OS mode.
- 2. Allow USB connections in ActiveSync connection settings.



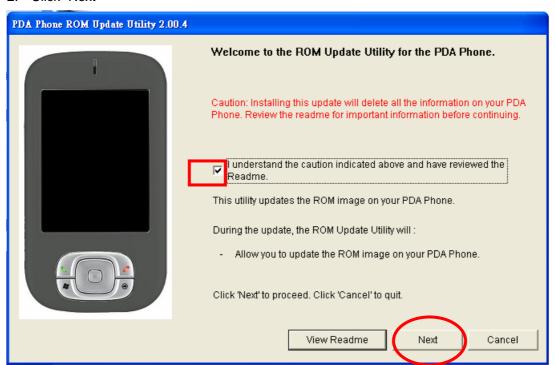
- 3. Connect with PC by USB cable.
- 4. Execute RUU program to re-flash ROM code.







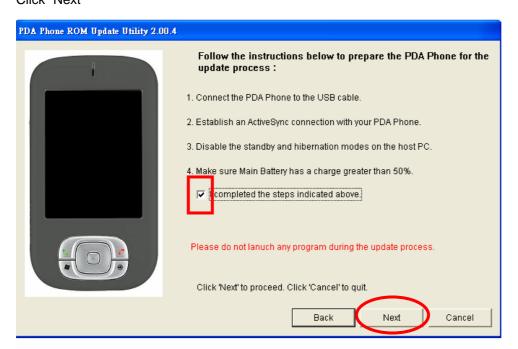
- 1. Check "I understand the action indicated above and have reviewed the Read me"
- 2. Click "Next"



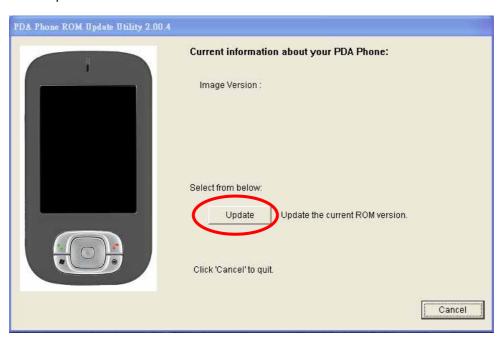




Check "I completed the steps indicated above" Click "Next"



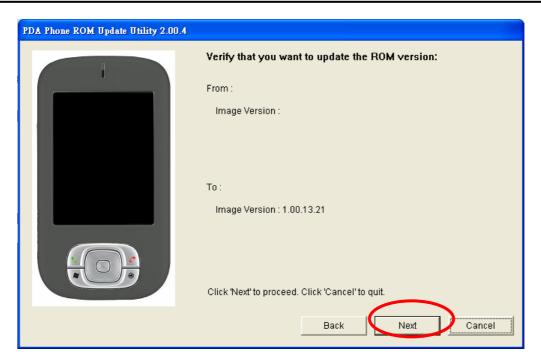
Click "Update"



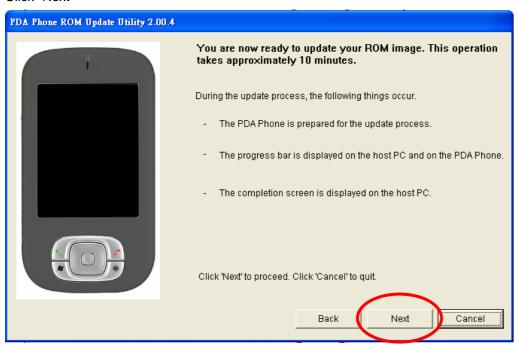
Click "Next"







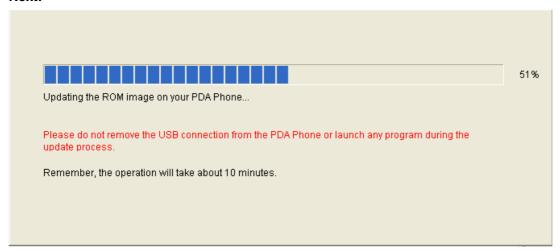
Click "Next"



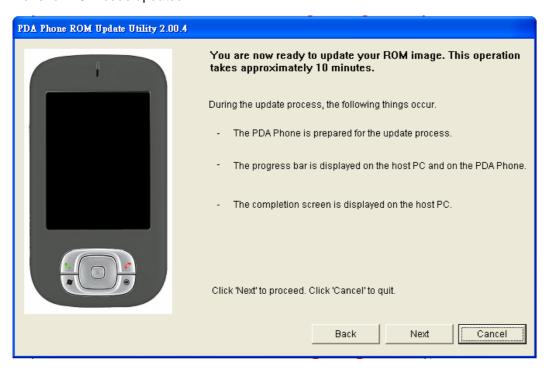




Next:



Done for ROM code updated







Execute hard reset!

Press and hold the Camera button+ Comm Manager button, at the same time use the stylus to press the RESET button.until the Following Hard Reset Screen is pop out, " Press Send to restore factory default or press others key to quit "

You can press Talk/Send key to do Hard Reset.



A. Upload most update code from master unit to SD /MMC card.

(You Only need to do this ONCE when New Update is received)

Requirement: (1) Mtty.exe tool ver. 116 (2) USB cable (3) Window2000 or above (4) Master unit with most update ROM image

1. Uncheck USB and COM1 in Connection Settings in ActiveSync if you have installed the ActiveSync in your PC and make sure the USB port is available.







Set the Unit into Bootloader Mode ((1) Press & hold the Camera Button with your Thumb and jab the reset with Stylus. (2) Release the Stylus but keep pressing the Camera Button until the Boot Loader Screen comes out), wait for Serial on display. Message on PDA Screen:

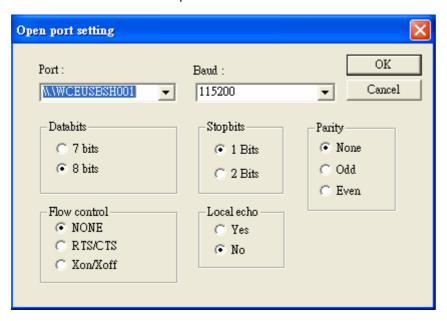


4 Connect the unit to the PC with USB cable or USB cradle, unit display will change to USB, and then open



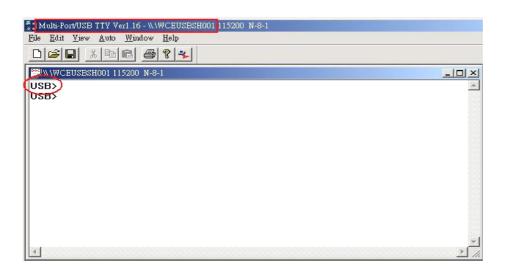


MTTY116.exe to select USB port.



- 4. Insert 64 MB SD or MMC card into SD slot of PDA Phone
- 5. On the PC side, Select OK and press ENTER.

Following display will be shown:



6. The prompt "USB>" will appear, to UPLOAD then type.

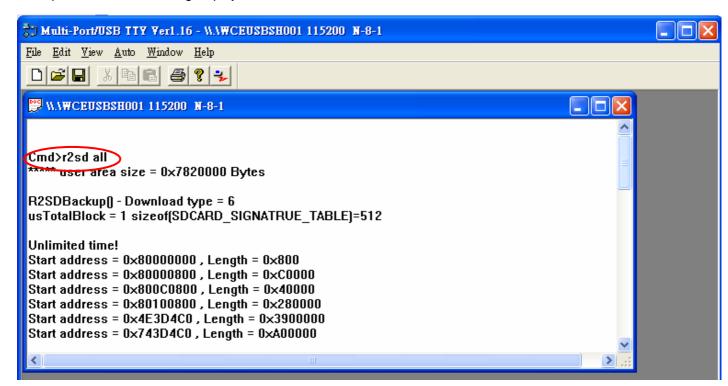
USB>r2xd all

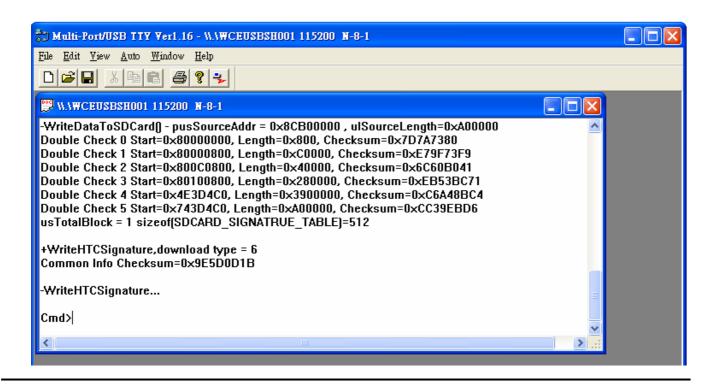




(Please notice the blank space between r2s and all)

Then press ENTER, following display will be shown:









Now the upload to SD card is done!

Take out the SD card from PDA phone and mark it according to the Language you build for.

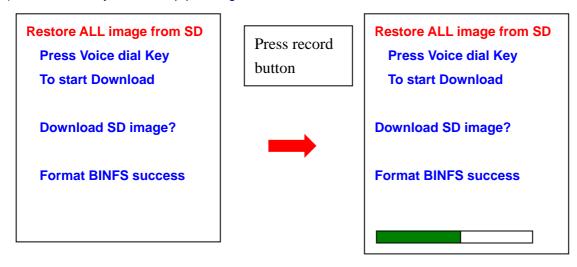
CAUTION! DO NOT REMOVE THE USB CABLE FROM THE PC OR PDA, FAIL TO DO SO MAY CAUSE DEVICE UNIT FAIL TO BOOT.





B. Use Pre-loaded SD card to Re-flash Unit.

- 1. Insert Pre-loaded SD card to the unit.
- 2. Reset the unit and enter the bootloader mode.
- (1) Press & hold the Camera Button with your Thumb and jab the reset with Stylus.
- (2) Release the Stylus but keep pressing the Camera Button until the Boot Loader Screen comes out.



3. Once it is done, display will show



- 5. Take out the SD card and Cold boot the device (unit).
- 6. Press and hold the Camera button+ Comm Manager button, at the same time use the stylus to press the RESET button.until the Following Hard Reset Screen is pop out, " Press Send to restore factory default or press others key to quit " You can press Talk/Send key to do Hard Reset.





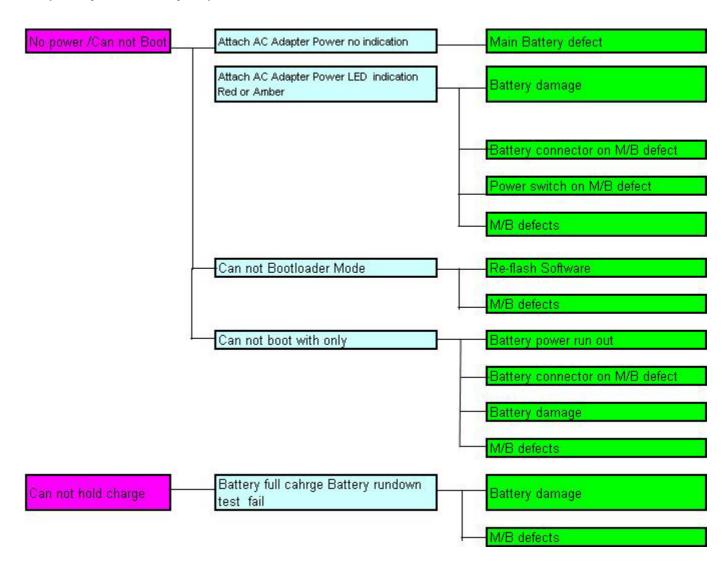
Now the upgrade is done!

Note: Due to security issue, it is not allowed to re-flash different customer ID.



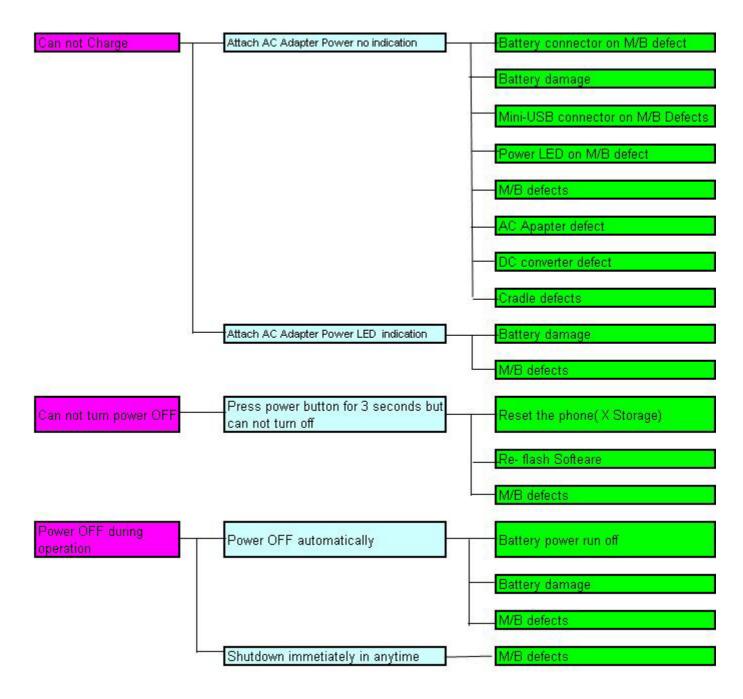


9. FTA (Faulty Tree Analysis)



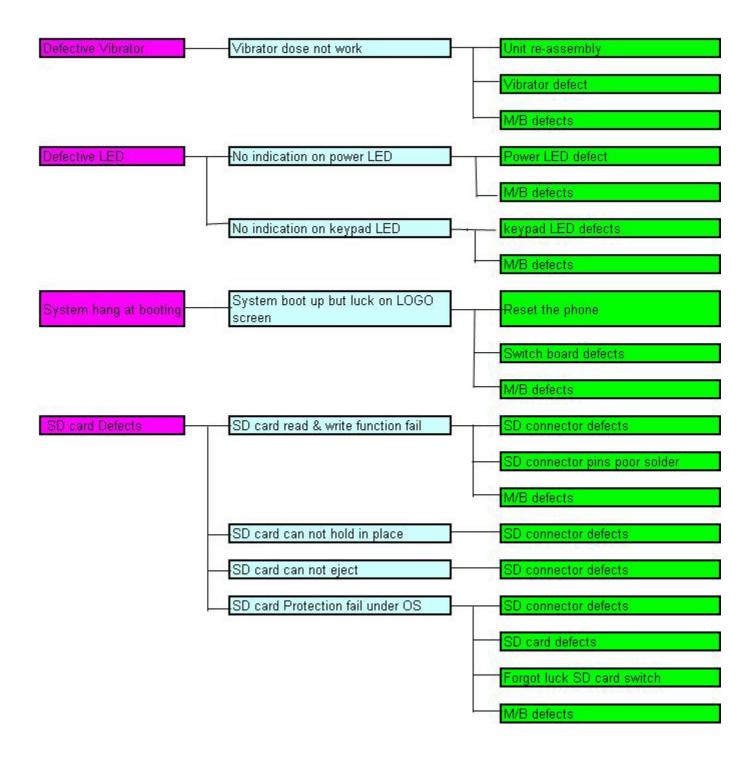












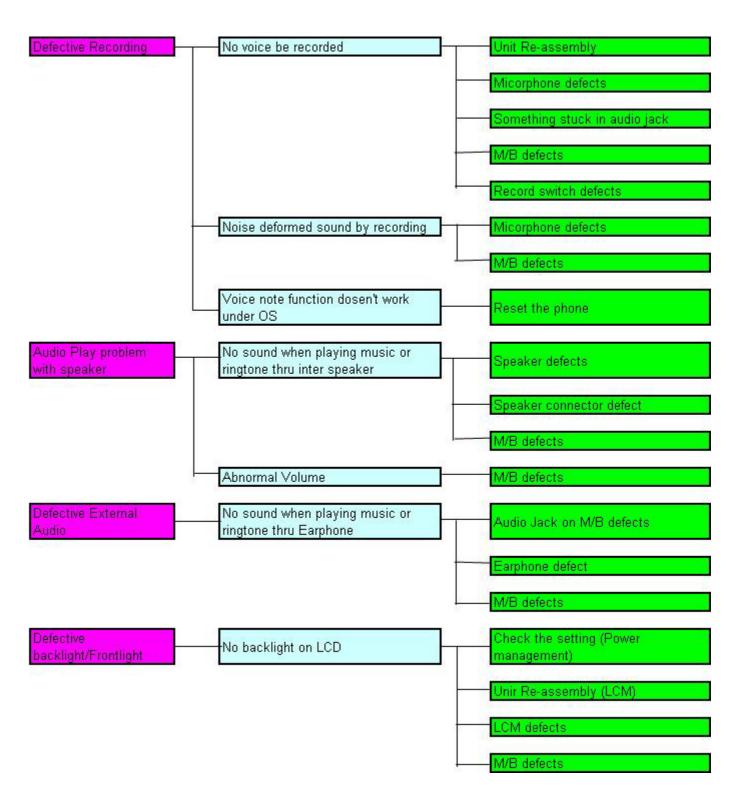




System hung under OS	System lock often under operation in anytime; press any key dosen't help	Reset the phone Re-flash software M/B defects
USB comunication	Can not sync with PC by ActiceSync	Checkcobbection setting in ActiveSync USB or Cradle cable defects Mini USB connector damage
Defective IR Dumb Speaker	No sound in internal speaker	M/B defects Check the setting (Sound ,profile) Something stuck in audio jack Unit Re-assembly Speaker defect M/B defects

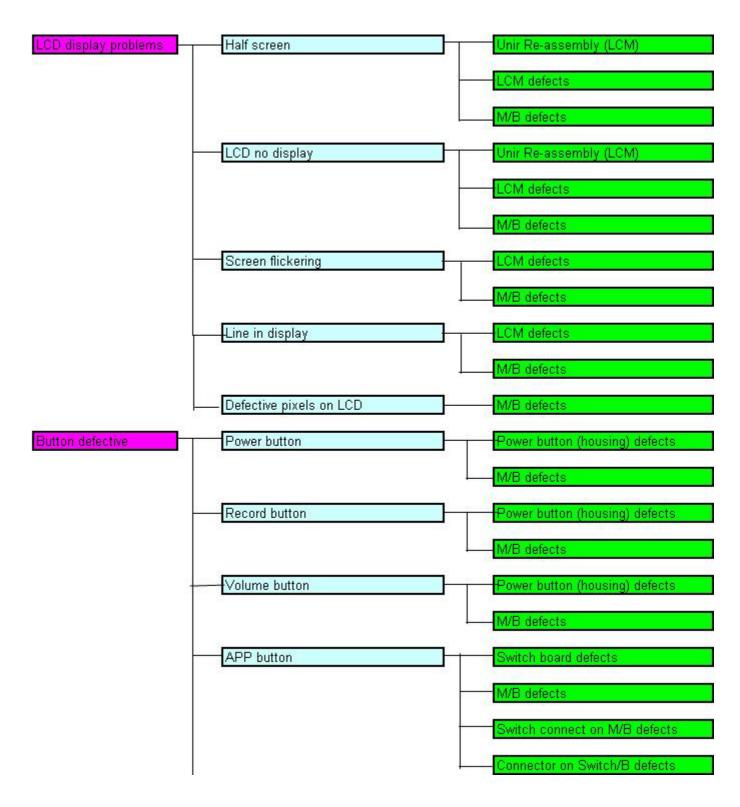






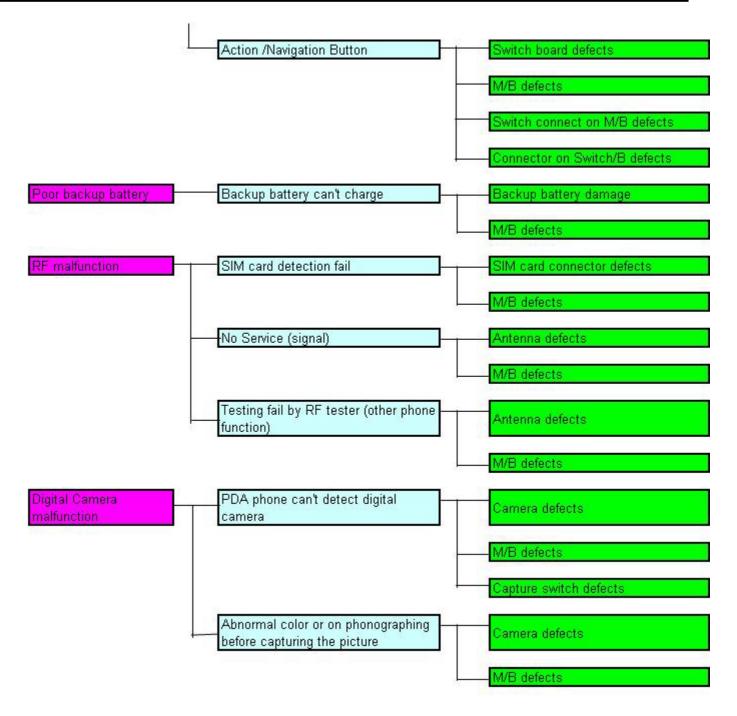
















10. Spare Part List

Prophet Part List

Item	HTCP/N	Description
1	35Н00051-03М	BATTERY_LI-POLYMER,1200mAh,3.7V,DYNAPACK,DAK500130-
2	36H00180-00M	Vibrator, Cylinder type, A4A-05-WTB-3, C.I. Kasei, dia. 4mm shell, dia. 5mm c.w., w/rubber
3	36H00253-01M	Receiver,8mm receiver with tape,WD20398/32,2403 263 00007,PHILIPS
4	36H00338-00M	Speaker,SAMBU,SBD201538P-CC02,20*15*3.8mm,Charmer
5	36H00345-01M	Antenna Pre-Assy, AMPHENOL, GAN40027, PROPHET
6	51H00320-50M	PCBA-MAIN BOARD, Toppoly LCM, WIFI, 2M Camera, PROPHET
7	51H00322-50M	PCBA,AUDIO BOARD,PROPHET
8	54H00150-00M	Module Assy, PREMIER, CMHT-21401T, Sensor: Samsung S5K3BAFB, 10*7.92mm
9	60Н00037-00М	LCD Module,TD028STEB1,Toppoly,Magician
10	71Н00960-00М	Holder, Audio-jack,PC,Magician
11	72H00339-00	SCREW,TORX,M1.6x8,NYLOK,L4.5
12	72H00498-00M	GASKET,AUDIO_RF,Pb-FREE,Vivida
13	72H00548-00M	Gasket,5*3.5*10mm,630GT,NAUTILUS
14	72H00724-00M	Screw,PH,FD,T1.4*2.9, Nickel,Black,AISI 1018
15	72H00782-00M	Copper Foil,LCM,Magician
16	72H01134-00M	EMI Gasket,SD-Holder,U-TEK,Charmer
17	72H01196-00M	EMI Gasket,RF-LCD,U-TEK,PROPHET
18	72H01197-00M	EMI Gasket,RF-SD,U-TEK,PROPHET
19	73Н20036-15М	FPC Pre-Assy,Switch Board,AFLEX,59.2*19.98*0.2mm,PROPHET
20	74H00537-01M	Keypad Pre-Assy,Silver,Prophet
20 A	74H00537-00M	Keypad Pre-Assy,Black,Prophet
21	74H00561-00M	Stylus Pre-Assy, Prophet
22	74H00562-01M	Bezel Pre-Assy,Silver,Dopod-Asia,Prophet-P2A
22A	74H00562-05M	Bezel Pre-Assy,Black,Dopod-Asia,Prophet-P2A
22B	74H00562-02M	Bezel Pre-Assy,Lavender,Dopod-Asia,Prophet-P2A
22C	74H00562-03M	Bezel Pre-Assy, Water Blue, Dopod-Asia, Prophet-P2A
22D	74H00562-04M	Bezel Pre-Assy,Pink,Dopod-Asia,Prophet-P2A
23	74H00563-01M	Cover Pre-Assy, Antenna, Silver, Prophet
23A	74H00563-00M	Cover Pre-Assy, Antenna, Black, Prophet
23B	74H00563-02M	Cover Pre-Assy, Antenna, Lavender, Prophet
23C	74H00563-03M	Cover Pre-Assy, Antenna, Water Blue, Prophet
23D	74H00563-04M	Cover Pre-Assy, Antenna, Pink, Prophet
24	74H00564-01M	Cover Pre-Assy, Battery, Silver, Prophet
24 A	74H00564-00M	Cover Pre-Assy,Battery,Black,Prophet
24B	74H00564-02M	Cover Pre-Assy,Battery,Lavender,Prophet
24C	74H00564-03M	Cover Pre-Assy, Battery, Water Blue, Prophet
24D	74H00564-04M	Cover Pre-Assy,Battery,Pink,Prophet





25	74Н00565-00М	Housing Pre-Assy, Prophet
26	76Н00748-00М	Spacer,rubber,Switch,Silicon,Magician
27	76Н00967-00М	Mylar,LCM,Toppoly,Magician
28	76Н01088-00М	Rubber, Microphone, Silicone, Charmer
29	76Н01093-00М	Conductive Gasket,Shielding-back,Charmer
30	76Н01125-00М	Rubber,PREMIER,Silicon,Camera,Prophet
31	76Н01209-00М	Mylar,STRAP,PROPHET
32	76H01214-00M	Mylar,Battery Connector,Charmer
33	76Н01215-00М	Tape,Battery PLATE,Charmer
34	76Н00398-01М	rubber-cover, antenna-cover, gray, Himalayas
34 A	76H00398-00	RUBBER-COVER, ANTENNA-CONN, HIMALAYAS
35	77H00203-00	Water Sensitive Label,4*2.5mm,Ming Jye,BlueAngels
36	77H00222-00M	Label security, Magician
37	77H00329-02M	Regulation Label, MING JYE, PM 300, w/IDA, Prophet-P2A, 35*0.0*41.0mm
38	77H00202-00M	Windows Mobile Branding Jewel Label, Colorado, GM

11. Spare Part Photo

35H00051-03		36H00180-00M	Sales Control	36H00345-01M	
Main Battery		Vibrator		Antenna	
Q'ty:1	-	Q'ty:1		Q'ty:1	- ALLENS
36H00338-00M		36H00253-01M	<u> </u>	51H00320-50M	
Speaker Assy		Receiver	(S)	Main Board	The same of
Q'ty:1		Q'ty:1		Q'ty:1	No. of Lot, Lot, Lot, Lot, Lot, Lot, Lot, Lot,
51H00322-50M		54H00150-00M	/Supa	60H00032- 00/60H00037-00M	
Audio Daughter	203	Camera			
Board		Module	PERSONAL SECTION SECTI	LCM Samsung	
Q'ty:1		Q'ty:1		Q'ty:1	-
71H00960-00M		76H00398-00		72H00339-00	
		rubber-cover,	a		. —
Holder Audio Jack		antenna-cover,		Screw TORX M1 6*8	
Q'ty:1		gray Q'ty:1		Q'ty: 4	
Gary. 1		Q (y . 1		Q (y . 4	





72H00498-00M		72H00548-00		72H00724-00M	
GASKET Audio RF		Gasket 5*3.5*10mm		Screw PH FD T1.4*2.9	-6
Q'ty:1		Q'ty:1		Q'ty:6	
72H00782-00M		73H20036-15M		74H00565-00M	
		Switch FPC Assembly		Housing Pre-	
Copper Foil LCM Q'ty:1		Q'ty:1		Assembly Q'ty:1	SSE:
741100500 2011		741100504 03/88		741100500 0411	
74H00562-X0M		74H00564-0XM		74H00563-0XM	6
Bezel Assembly		Cover Battery		Cover Antenna	(c)
Q'ty:1		Q'ty:1		Q'ty:1	
74H00561-00M		74H00537-00M		76H00748-00M	
Stylus		Keypad Navigation	000	Spacer Rubber	
Q'ty:1		Q'ty:1		Q'ty:1	
76H01125-00M		76H00754-00M		76H01088-00M	
Rubber camera		Mylar Battery Connector		Boot Microphone	8
041	NAME:	Q'ty:1		041	
Q'ty:1		Q Ly . 1	#ETTT WALL	Q'ty:1	
77H00222-00M		76H00724-00M DUMMY,SD,CARD,		72H00831-00M Dome Metal Switch	but but d
Security label	Political	HIMALAYAS		Magician,SUS-301	
Q'ty:1		Qty:1		Q'ty:1	
77H00203-00		36H00310-00M		76H01093-00M	The state of the s
Water Sensitive Label,4*2.5mm,Mi	600	Earphone, EACETECH, TS	0	Conductive Gasket,Shielding-	lost Control of the C
ng Jye,		888-03206N-\M-01ZS	15	back,Charmer	
Q'ty:1	The state of the s	Q'ty : 1		Q'ty:1	
72H01196-00M		72H01197-00M		72H01134-00M	
EMI Gasket,RF-LCD,U- TEK,PROPHET	2.5456	EMI Gasket, RF-SD, U- TEK, PROPHET	1239569	EMI Gasket,SD-Holder,U- TEK,Charmer	0
Q'ty:2	V. T. S.	Q'ty : 1		Q'ty:1	0





Appendix

A. Customer, Retailer Misjudgment

Before attempt repairing the unit, make sure the type of reported failure could be clearly reproduced; otherwise, check with the customer or distributor once again to identify the problem correctly.

The following are failure symptoms that are typical by misjudgment

No.	Item	Possibility
		Main Battery low power exhausted.
	No Power even the power	While Back Light is turned OFF, the surrounding lighting will be reflected on the
1	button is pressed	panel and in a dim location, it looks like the unit is turned OFF.
		According to the Power Management settings, the units will be switched OFF
		automatically.
		The battery life depends on the devices being used in SD Card Slot, and
2	Battery discharges quickly	frequency of use of the Backlight. These functions consume a lot of energy.
	Dattery discriarges quickly	Operating with front light ON, or using high-energy consumption devices such as
		SD Memory Card will drain out the battery pack faster.
		Using AC adapter that is NOT supplied with the unit.
		Charging the battery while operating the unit with heavy loadings could cause the
		temperature inside the unit to build up which could cause the unit stop charging. At
3	Battery cannot be charged	this moment, the LED indicator will flash Yellow to notify user that the charging has
		been stopped. Or the temperature is extremely low will also stop charging.
		Since the extreme high or low temperature will cause the battery to discharge
		quickly, it has been designed to cut battery charge below 0 and above 35~40
		to protect the battery pack.
	Cannot make	If the unit could pass the test with Loop back Interface card, the possibility of unit
4	communications via mobile	malfunction becomes low. Then the following items could be the reason of
	phones through exclusive	problem such as location, timing, signal strength, service provider's mixed up, or
	cable.	problem with the mobile itself. Or could be incompatibility issue.
	Cannot use SD	Card is not being pre-formatted.
5	Memory Card	SD card has been switched to Write Protect mode.
	,	Card not inserted completely, or bad contact between connector contacts.
	Black or White dot on the	For LCD panel's normal behavior, it is hard to find a panel without any bad pixel.
6	screen.	Once the numbers of dots and the distance between them are within the
		specifications, it is allowed.
7	Touch Screen or Program	Could be wrong operation.





	1			
	Buttons are not reacting.	Screen not properly aligned with the stylus calibration.		
	Front Light dim, cannot turn			
8	ON, or shuts OFF	Check the Front Light settings in Power Management settings		
	automatically.			
	Cannot playback music, No	When Battery low, the music playback becomes difficult and the volume could		
ç	sound or volume is low.	become lower.		
4	Cannot execute installed	Cauld be an incompatible anthurs		
1	application programs	Could be an incompatible software		
4	Operation is slow in	Could be in a first manner of the state of t		
1	response	be insufficient memory. Check amount of system memory.		
		Software being used sometimes is not fully compatible with the system.		
4	2	Execute many application programs simultaneously		
1.	2 Hang up	Software that requires big amount of memory spaces or the system memory is low		
		or the files being used is fragmented.		
	Overteen Manageria anavel			
1		Software that requires big amount of memory spaces or the system memory is low		
	but is shows insufficient.	or the files being used is fragmented.		

^{*}Note: Nevertheless, the above symptoms could be solved by a warm boot or cold boot, make sure the warm/cold boot has been executed and try to reproduce the symptom reported.

How to perform Warm Boot and Cold Boot:

Warm Boot: Reset the unit by pressing reset button.

Cold Boot: Execute hard reset!

Press and hold the Camera button+ Comm Manager button, at the same time use the stylus to press the RESET button.until the Following Hard Reset Screen is pop out, " Press Send to restore factory default or press others key to quit " You can press Talk/Send key to do Hard Reset.





B. Labeling Plan (Generic)

B.1 Main unit Regulatory label (on the rear housing of main unit)

It includes:

Unit IMEI & Barcode

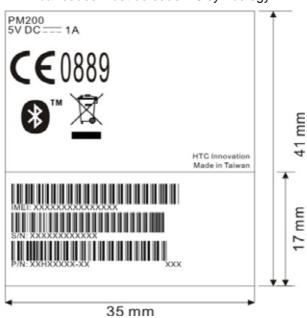
Unit Serial Number & Barcode

Unit Part Number & Barcode

Image file name: MAIN_UNIT_REGULATION

Please note: 1. The brand name is shown on Bezel.

2. All bar codes must be code128 symbology.



B.2 Definition of Serial Number

For S/N: **SSYWWPPZZZZZ**

SS: SITE CODE → HT

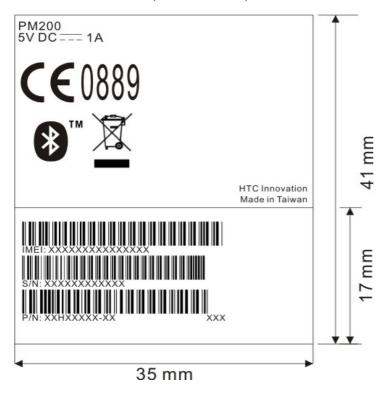
Y: Year Last Digital of the Year.

WW: Week Code: **01 ~ 54**PP: Product Code: **BE**





ZZZZZ: Serial Number (00001 ~ 99999) Use Base 10



Label Characteristic:

Material: polyester Color: pantone 422c Ink: pantone 425c

C. RF Antenna Test Specification





Items	Test Name	TxLevel	тсн	lst Downlink CellPower	Note
1	Camp @ DCS Band	0	512	-75	BCCH≠600
2	BS Originate Call	0	512	-75	
	E-GSM	900 ReceiverTest	t		
3	Fast Bit Error Rate	5	975	-104	
4	Fast Bit Error Rate	5	42	-104	
5	Fast Bit Error Rate	5	124	-104	
	E-GSM 9	00 Ttansmitter Te	st		
6	TX Phase RMS Error	5	975	-104	
7	TX Phase Peak Error	5	975	-104	
8	TX Frequency Error	5	975	-104	
9	TX Phase RMS Error	5	42	-104	
10	TX Phase Peak Error	5	42	-104	
11	TX Frequency Error	5	42	-104	
12	TX Phase RMS Error	5	124	-104	
13	TX Phase Peak Error	5	124	-104	
14	TX Frequency Error	5	124	-104	
15	Check TX Power	5	975	-104	
16	Check TX Power	5	42	-104	
17	Check TX Power	5	124	-104	





	DCS 1800 ReceiverTest						
1	Fast Bit Error Rate	0	512	-104			
2	Fast Bit Error Rate	0	<i>6</i> 98	-104			
3	Fast Bit Error Rate	0	8885	-104			
	DCS 180	0 Ttansmitter Tes	t				
4	TX Phase RMS Error	0	512	-104			
5	TX Phase Peak Error	0	512	-104			
6	TX Frequency Error	0	512	-104			
7	TX Phase RMS Error	0	<i>6</i> 98	-104			
8	TX Phase Peak Error	0	<i>6</i> 98	-104			
9	TX Frequency Error	0	<i>6</i> 98	-104			
10	TX Phase RMS Error	0	885	-104			
11	TX Phase Peak Error	0	885	-104			
12	TX Frequency Error	0	885	-104			
13	Check TX Power	0	512	-104			
14	Check TX Power	0	<i>6</i> 98	-104			
15	Check TX Power	0	885	-104			

	PCS 19	900 ReceiverTest			
1	Fast Bit Error Rate	0	512	-104	
2	Fast Bit Error Rate	0	661	-104	
3	Fast Bit Error Rate	0	810	-104	
	PCS 190	O Ttansmitter Tes	t		
4	TX Phase RMS Error	0	512	-104	
5	TX Phase Peak Error	0	512	-104	
6	TX Frequency Error	0	512	-104	
7	TX Phase RMS Error	0	<i>66</i> 1	-104	
8	TX Phase Peak Error	0	<i>66</i> 1	-104	
9	TX Frequency Error	0	<i>66</i> 1	-104	
10	TX Phase RMS Error	0	810	-104	
11	TX Phase Peak Error	0	810	-104	
12	TX Frequency Error	0	810	-104	
13	Check TX Power	0	512	-104	
14	Check TX Power	0	<i>66</i> 1	-104	
15	Check TX Power	0	810	-104	





	GSM 850 ReceiverTest						
1	Fast Bit Error Rate	0	128	-104			
2	Fast Bit Error Rate	0	189	-104			
3	Fast Bit Error Rate	0	251	-104			
	GSM 85	0 Ttansmitter Tes	t				
4	TX Phase RMS Error	0	128	-104			
5	TX Phase Peak Error	0	128	-104			
6	TX Frequency Error	0	128	-104			
7	TX Phase RMS Error	0	189	-104			
8	TX Phase Peak Error	0	189	-104			
9	TX Frequency Error	0	189	-104			
10	TX Phase RMS Error	0	251	-104			
11	TX Phase Peak Error	0	251	-104			
12	TX Frequency Error	0	251	-104			
13	Check TX Power	0	128	-104			
14	Check TX Power	0	189	-104			
15	Check TX Power	0	251	-104			

D. Board Level 2.5 Repairs

A. Components to be replaced

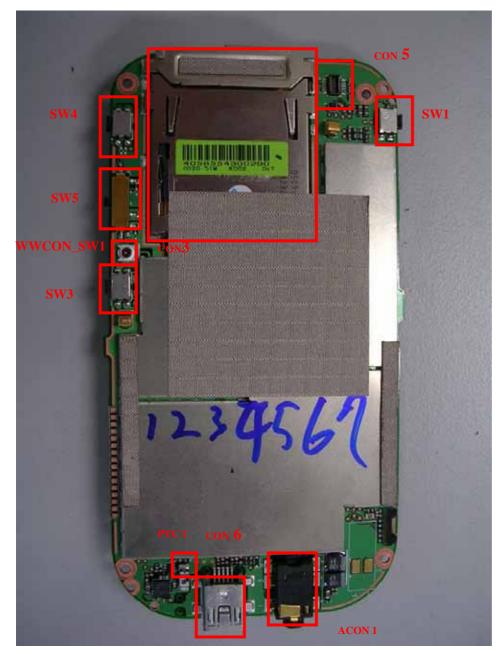
I. Main Board: ONLY the following items have been allowed to replace for M/B.

Obverse side

- 1. SD Card Slot (CON3)
- 2. Audio daughter Connector (CON5)
- 3. Power Switch (SW1)
- 4. Capture Switch (SW4)
- 5. Volume Slide Switch (SW5)
- 6. Record Switch (SW3)
- 7. Mini-USB connector (CON6)
- 8. Audio Jack (ACON1)
- 9. FUSE (PTC1)







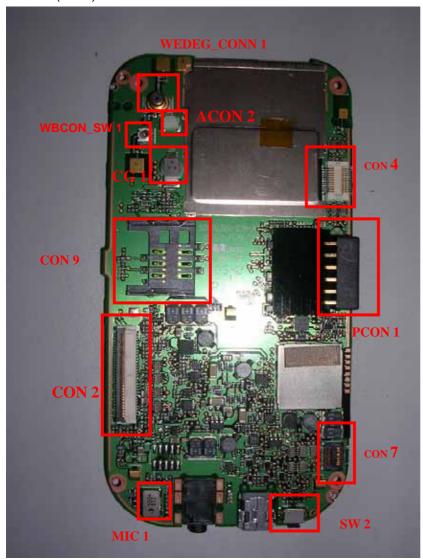
Reverse side

- 1. Connector RF, WEDEG (WEDEG CONN1)
- 2. Speaker connector (ACON2)
- 3. Battery Connector (PCON1)
- 4. SIM Card Connector (CON9)
- 5. LCM connector (CON2)
- 6. COAXIAL CONNECTOR (WBCON_SW1)





- 7. Reset Key (SW2)
- 8. Switch board connector (CON7)
- 9. Gold Cap, 0.07F, 700hm, 3.3V (CG1)
- 10. Camera connector (CON4)
- 11. MIC (MIC1)



- **B. Problem Identification & Troubleshooting**
- I. Basic Repair Instructions for Component Replacement:
 - **Step 1**. Place the solder-proof tape to cover the surrounding area of the components which being replaced.

Warning: DO NOT overheat the tape and components to avoid the tape melted and make the component damage.

Step 2 Use Heater Gun (HAKO850B, set the temperature between





- 350 , Air Speed 3~5) to remove the components.
- **Step 3** It has to wait the temperature cool down before the damaged components been removed. Or, the others components could be gone when the solder-proof tape been taken off.
- **Step 4** After the damaged components has been replaced; clean the surroundings for solder and flux residues.
- II. Main Board: The following items have been allowed to replace for Main Board
- 1. Recording Switch (SW3), Camera Switch (SW4), Reset Switch (SW2), Power Switch (SW 1)

 If the switch is broken, warp or doesn't work properly (measure by scope), replace it.
- 1.1 If the switch still doesn't work properly after replace new one, please replace the M/B.

2. Camera FPC Connector (CON4)

- 2.1 If the connector is broken, warp or doesn't work properly (measure by scope), replace it.
- 2.2 If the connector still doesn't work properly after replace new one, please replace the M/B.

3. Mini-USB Connector (CON6)

- 3.1 If the connector is broken, warp or doesn't work properly (measure by scope), replace it.
- 3.2 If the connector still doesn't work properly after replace new one, please replace the M/B.

4. Audio Jack (ACON 1)

- 5.1 If the connector is broken, warp or doesn't work properly (measure by scope), replace it.
- 5.2 If the connector still doesn't work properly after replace new one, please replace the M/B.

5. LCD FPC Connector (CON2)

- 5.1 If the connector is broken, warp or doesn't work properly (measure by scope), replace it.
- 5.2 If the connector still doesn't work properly after replace new one, please replace the M/B.
- 5.3 Place solder-proof tape on CON2 to prevent it melted when using heater gun to remove CON2.

6. Switch Board FPC Connector (CON7)

- 6.1 If the connector is broken, warp or doesn't work properly (measure by scope), replace it.
- 6.2 If the connector still doesn't work properly after replace new one, please replace the M/B.
- 6.3 Place solder-proof tape on CON6 to prevent it melted when using heater gun to remove CON6

7. Battery Connector (PCON 1)





- 7.1 If the connector is broken, warp or doesn't work properly (measure by scope), replace it.
- 7.2 If the connector still doesn't work properly after replace new one, please replace the M/B.

8. Gold Cap (CG1)

8.1 If the Golden cap function failure (can not keep the date, RTC failure) replace it. Replace process:

- A. Remove CG1 (DO NOT use Heater Gun to remove)
- B. Take a new one for replace:

Notice: 1. Set up the welding iron temperature 350 degree C

- 2. Don't stay on the pins (positive and negative pin) of component (CG1) over 5 seconds.
- 3. Don't contact the component body with welding iron directly.
- 8.2 If the component doesn't work properly after replace new one, please replace the M/B.

9. SIM Card Connector (CON 9)

- 9.1 If the connector is broken, warp or doesn't work properly (measure by scope), replace it.
- 9.2 If the connector still doesn't work properly after replace new one, please replace the M/B.
- 9.3 Use solder iron only to replace new component. DO NOT use Heater Gun to remove component to prevent next connector melted.

10. WEDEG RF connector (WEDEG CONN1)

- 10.1 If the switch is broken, warp or doesn't work properly (measure by scope), replace it.
- 10.2 If the switch still doesn't work properly after replace new one, please replace the M/B.

11. FUSE (PTC 1)

- 11.1 If the switch is broken, warp or doesn't work properly (measure by scope), replace it.
- 11.2 If the switch still doesn't work properly after replace new one, please replace the M/B.

12. Volume Control Switch (SW5)

- 12.1 If the switch is broken, warp or doesn't work properly (measure by scope), replace it.
- 12.2 If the switch still doesn't work properly after replace new one, please replace the M/B.

13. SD Card Slot (CON3)

- 13.1 If the slot is broken, warp or doesn't work properly (measure by scope), replace it.
- 13.2 If the slot still doesn't work properly after replace new one, please replace the M/B.





B. Prophet Part List for Board Level Repair

Prophet BOARD LEVEL Spare part List

Item	Description	HTC P/N	Using Qty	Location	Remark
1	36H00129-00M	SWITCH BUTTON,PTS-106,HCH,4.7*4.5*1.65,70/-20degC,BLUE ANGELS	4	SW1,2,3,4	
2	36H00160-00M	Slide_Switch,HSS112,HCH 1	1	SW5	
3	36H00256-00M	2.5 MM AUDIO JACK,DTJ-0281,12.5* 7 *4 MM,DIHTAIN	1	ACON1	
4	36H00301-00M	Fuse,PTC,1.5A, 6V 0.04 ohm~0.12 ohm,0.08ohm,+/-50%,1206,SMD1206P150TF,POLYTRONICS,85/	1	PTC1	
5	75H00204-00M	CONNECTOR,B-TO-FPC,FH23-61S-0.3SHAW(05),PITCH=0.6mm,HRS	1	CON2	
6	75H00228-00M	Connector Others,SM02B-SURS-TF(LF),JST	1	ACON2	
7	75H00248-00M	COAXIAL CONNECTOR,RF,WITH SWITCH,SMD,MM8430-2600RA1,MURATA	1	WWCON_SW1	
8	75H00248-00M	COAXIAL CONNECTOR, RF, WITH SWITCH, SMD, MM8430-2600RA1, MURATA	1	WBCON_SW1	
9	75H00321-00M	Connector RF,4P,LPC TP-1,120220-0129,ITT Cannon,Pb-FREE	1	WEDED_CONN1	
10	75H00395-00M	Connector SIM Card,50mohm,ICC-429,hamburg	1	CON9	
11	75H00396-00M	Connector, Battery, 6PIN, Pitch=2.5mm, R-angle, BTR1M-6K2000, Acon 1	1	PCON1	
12	75H00397-00M	Connector B to B,22P,0.5pitch,AXX/5F22345Y,MATSUSHITA	1	CON4	
13	75H00400-00M	Connector I/O,male,mini-usb,MNE41-5G5P10, type ab, straddle type,ACON	1	CON6	
14	75H00402-00M	Connector B to B,AXK814145Y,70mohm,14P,0.4mmPitch,0.3A,60V,Matsushita	1	CON5	
15	75H00415-00M	Connector B to B,Female,20pin,Pitch=0.4mm,AXK7L20227,Matsushita	1	CON7	
16	16H00012-00M	Gold Cap, 0.07F, 70ohm, 3.3V, -25/+50%, XH414H II02EY, SEIKO, 7.6*4.8*1.72mm, 70/-25degC	1	CG1	
17	36H00208-00M	MIC,SP0103NC3,EMKAY,Pb-FREE,100/-40degC,6.15*3.76*1.45 mm	1	MIC1	
18	75H00450-00M	Connector SDIO,15P,2.5mmPitch,0.5A,AXA29200933,MATSUSHITA	1	CON3	